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A. H. H.

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of

Takahashi, Y. et al.

Serial No.: Not Yet Assigned

Group Art Unit: Not Yet Assigned

Filing Date: Concurrently Herewith

Examiner: Unknown

For: SAW FILTER DEVICE AND PACKAGE FOR ACCOMMODATING THE SAME

Assistant Commissioner of Patents  
Washington, D.C. 20231

**PRELIMINARY AMENDMENT**

Sir:

Prior to examination on the merits and calculation of the filing fee, please amend the above-identified application as follows:

**IN THE CLAIMS:**

**Please amend the claims as follows:**

4. (Amended) The SAW filter device, according to claim 1, which further comprises a film of a conductive material covering the front surface of the chip substrate and the interdigital transducers.

11. (Amended) An SAW filter device including an SAW filter according to claim 1, which comprises a plastic package including a terminal member made of metal extending out of the package and extending into the package such as to form an L-shaped portion, the chip substrate being accommodated in the plastic package such that the back surface of the chip substrate is in contact with the L-shaped portion.